



20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
20V	0.99Ω @ V _{GS} = 4.5V	0.55A
	1.2Ω @ $V_{GS} = 2.5V$	0.50A
	1.8Ω @ V _G S = 1.8V	0.41A
	2.4Ω @ V _G S = 1.5V	0.35A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

Applications

- General-purpose interfacing switches
- · Power-management functions
- Analog switches

Features and Benefits

- Low Package Profile, 0.42mm Maximum Package Height
- 0.62mm × 0.62mm Package Footprint
- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V Maximum
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (DMN2991UFZQ)

Mechanical Data

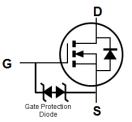
- Package: X2-DFN0606-3
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.001 grams (Approximate)



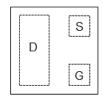




Bottom View



Equivalent Circuit



Top View Package Pin Configuration

Ordering Information (Note 4)

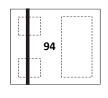
Part Number	Daskaga	Packing		
	Package	Qty.	Carrier	
DMN2991UFZ-7B	X2-DFN0606-3	10k	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information

X2-DFN0606-3



94 = Product Type Marking Code Bar Denotes Gate and Source Side

Top View



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			VDSS	20	V
Gate-Source Voltage			Vgss	±8	V
Continuous Drain Current (Note 5) $V_{GS} = 4.5V$ Steady $T_A = +25^{\circ}C$ $T_A = +75^{\circ}C$		ID	0.55 0.44	А	
Maximum Body Diode Forward Current (Note 6)			Is	0.7	Α
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)			IDM	1.5	A

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 5)	Steady State	PD	0.45	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	279	°C/W
Power Dissipation (Note 6)	Steady State	P _D	0.53	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	148	°C/W
Operating and Storage Temperature Range	·	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	20	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 16V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	1	μΑ	$V_{GS} = \pm 5V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.4	0.8	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
		_	0.60	0.99		$V_{GS} = 4.5V, I_D = 100mA$	
		_	0.75	1.2		Vgs = 2.5V, ID = 50mA	
Static Drain-Source On-Resistance	RDS(ON)	_	0.90	1.8	Ω	Vgs = 1.8V, ID = 20mA	
		_	1.2	2.4		Vgs = 1.5V, ID = 10mA	
		_	2.0	_		Vgs = 1.2V, ID = 1mA	
Diode Forward Voltage	VsD	_	0.6	1.0	V	Vgs = 0V, Is = 150mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	21.5	_	pF		
Output Capacitance	Coss	_	4.9	_	pF	V _{DS} = 16V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	3.7	_	pF	1 = 1.0IVII 12	
Total Gate Charge	Qg	_	0.35	_	nC		
Gate-Source Charge	Q _{gs}	_	0.07	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$	
Gate-Drain Charge	Q_{gd}	_	0.08	_	nC	I _D = 250mA	
Turn-On Delay Time	tD(ON)	_	5.6	_	ns	V _{DD} = 10V, V _{GS} = 4.5V,	
Turn-On Rise Time	t _R	_	4.9	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	60.6	_	ns	$R_L = 47\Omega, R_g = 10\Omega,$ $I_D = 200 \text{mA}$	
Turn-Off Fall Time	tF	_	27.6	_	ns	TID = ZUUITA	
Reverse Recovery Time	trr	_	12.3	_	ns	I _F = 1.0A, di/dt = 100A/μs	
Reverse Recovery Charge	Q _{RR}	_	1.1	_	nC	I _F = 1.0A, di/dt = 100A/μs	

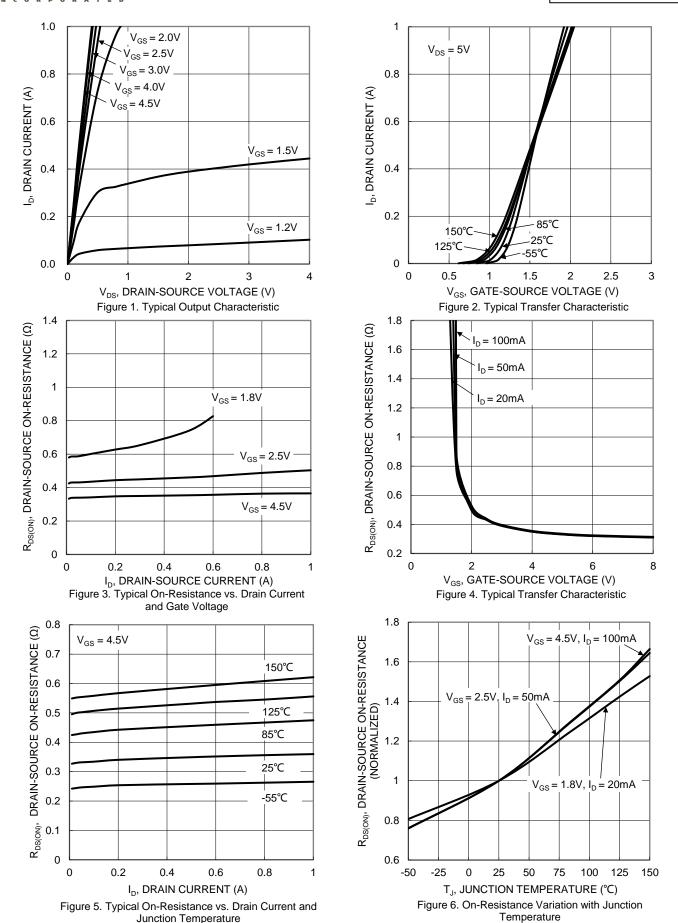
Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.

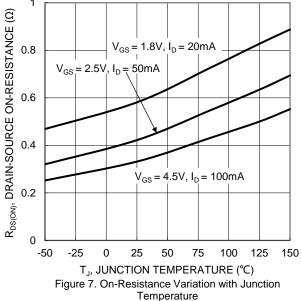
^{7.} Short duration pulse test used to minimize self-heating effect.

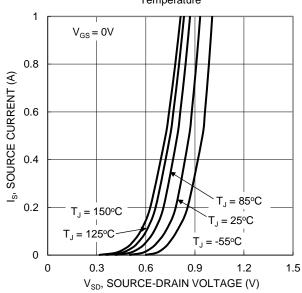
^{8.} Guaranteed by design. Not subject to product testing.

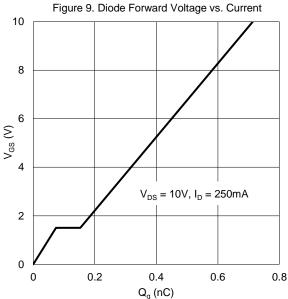


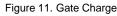












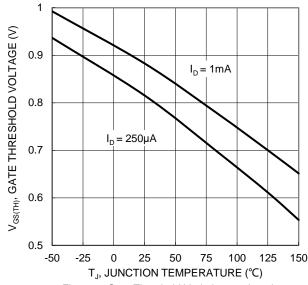


Figure 8. Gate Threshold Variation vs. Junction Temperature

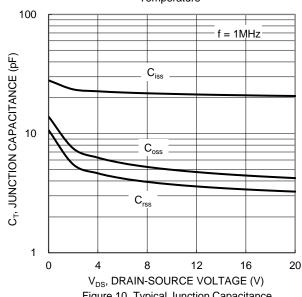
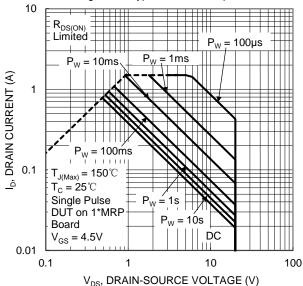


Figure 10. Typical Junction Capacitance





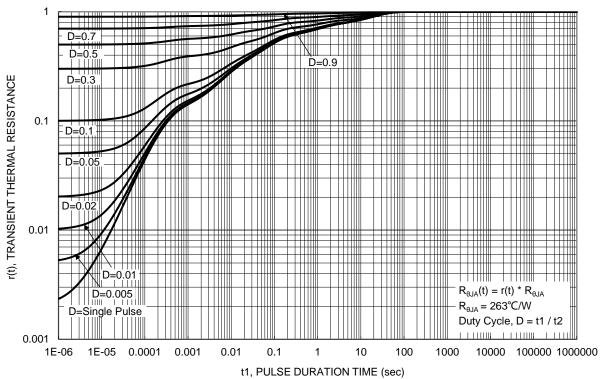


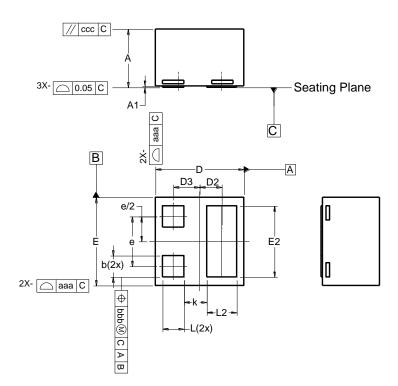
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0606-3

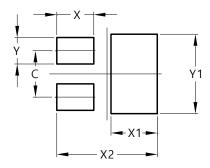


X2-DFN0606-3					
Dim	Min Max		Тур		
Α	0.36	0.40	0.39		
A1	0.00	0.05	0.02		
b	0.10	0.20	0.15		
D	0.57	0.67	0.62		
D2	0.155 BSC				
D3	0.	0.185 BSC			
Е	0.57	0.57 0.67 0			
E2	0.40	0.60	0.50		
е	0.35 BSC				
k	0	.16 RE	F		
L	0.10	0.20	0.15		
L2	0.11	0.31	0.21		
aaa	0.08				
bbb	0.07				
CCC	0.05				
All Dimensions in mm			n mm		

Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

X2-DFN0606-3



Dimensions	Value (in mm)
C	0.350
Х	0.280
X1	0.350
X2	0.760
Y	0.200
Y1	0.600



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